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INDICATED ABOVE AND IS ADDRESS BOX 1450, ALEXANDRIA, VA 22313-14	ED TO: MAIL STOP PATENT APPLICATION, COMMISSIONER F	OR PATENTS, P.O.
HILLARY DIXON (SENDER'S PRINTED NAME)	Allias (Allias (Signature)	

Mail Stop Patent Application Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Enclosed for filing is a patent application under 37 CFR 1.53(b) of:

Inventor:

Dae-Woo Son, Jin-Hyuk Lee and Kwan-Jai Lee

For:

TAPE CIRCUIT SUBSTRATE HAVING WAVY BEAM LEADS AND

SEMICONDUCTOR CHIP PACKAGE USING THE SAME

Applicant requests FIG. 4A to be published with the application.

Encl	sures	•
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$\boxtimes$	Specification (pages 1-10); claims (pages 11-15); abstract (page 16)
$\boxtimes$	TEN sheet(s) of FORMAL drawings (comprising 18 figures)
$\boxtimes$	Combined Declaration and Power of Attorney (newly executed)
	Assignment with cover sheet
	Assignee Name and Address: Samsung Electronics Co., Ltd., Kyunggi-do, Republic of Korea
$\boxtimes$	Certified copy of Priority Document No. 2002-15179, filed March 11, 2003 (priority claimed)
$\boxtimes$	Form PTO 1449 (with 8 cited references)

CLAIMS AS FILED							
For	Number Filed	Number Extra	Rate		Basic Fee \$770		
Total Claims	39-20	19	x \$ 18	=	342		
Independent Claims	5-3	2	x \$ 86		172		
TOTAL FILING FEE					\$1284.00		

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Respectfully submitted,

MARGER JOHNSON & McCOLLOM, P.C.

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